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In re the Application

Inventors:

Masanori MINAMIC

Art

Unit:

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H. Cee
CFR

Application No.:

09/380,312 ✓

Filed:

August 31, 1999

For:

RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A
METHOD OF MANUFACTURING THE SAME

REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner of Patents
Washington, D.C. 20231

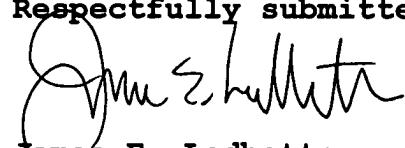
Sir:

Please issue a Corrected Filing Receipt reflecting corrected
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Filing Date: August 31, 1999

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Respectfully submitted,


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Date: February 13, 2001

JEL/clw

ATTORNEY DOCKET NO. JEL 30763 PCT

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/380,312	09/24/2000	2811	1438	JEL-30763- PC	6	15	9 08/31/1999

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Continuing Data as Claimed by Applicant

THIS APPLICATION IS A 371 OF PCT/JP98/02544 06/08/1998

Foreign Applications

JAPAN 9-171395 06/27/1997
JAPAN 10-73711 03/23/1998

Title

Resin molded type semiconductor device and a method of manufacturing the same

Preliminary Class

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